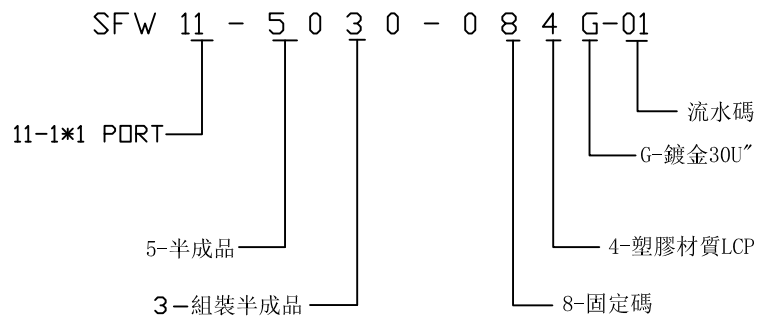
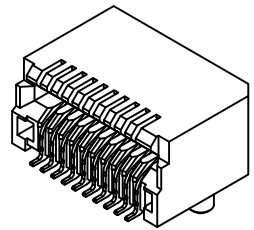


NOTES:

- 1.MATERIAL
HOUSING: HIGH TEMPERATURE LCP, Black, UL94 V-0.
- 2.CONTACTS: PHOSPHOR BRONZE
PLATING :30μ" GOLD ON MATING AREA,
GOLD FLASH PLATING ON
SOLDER TAILS, 50μ" NICKEL
UNDERPLATING OVERALL.
3. MECHANICAL REQUIREMENT:
3.1 DURABILITY:100 CYCLES MIN.
3.2 INSERTION AND EXTRACTION FORCE:40N MAX. & 11.5N MAX.
4. ENVIRONMENTAL:
4.1 CONTACT RESISTANCE:20 MILLIOHMS MAX INITIAL.
4.2 DIELECTRIC WITHSTANDING VOLTAGE: 300V AC/MIN.
4.3 CURRENT RATING: 0.5 Amps Max.
4.4 OPERATION: -40°C TO +95°C
4.5 STORAGE: -55°C TO +105°C
4.6 REFLOW SOLDERING TEMPERATURE: 255~265° MAXIMUM
FOR 5~10 SECONDS.
4.9 ROHS COMPLIANT
- 5.PACKAGING: TAPE AND REEL

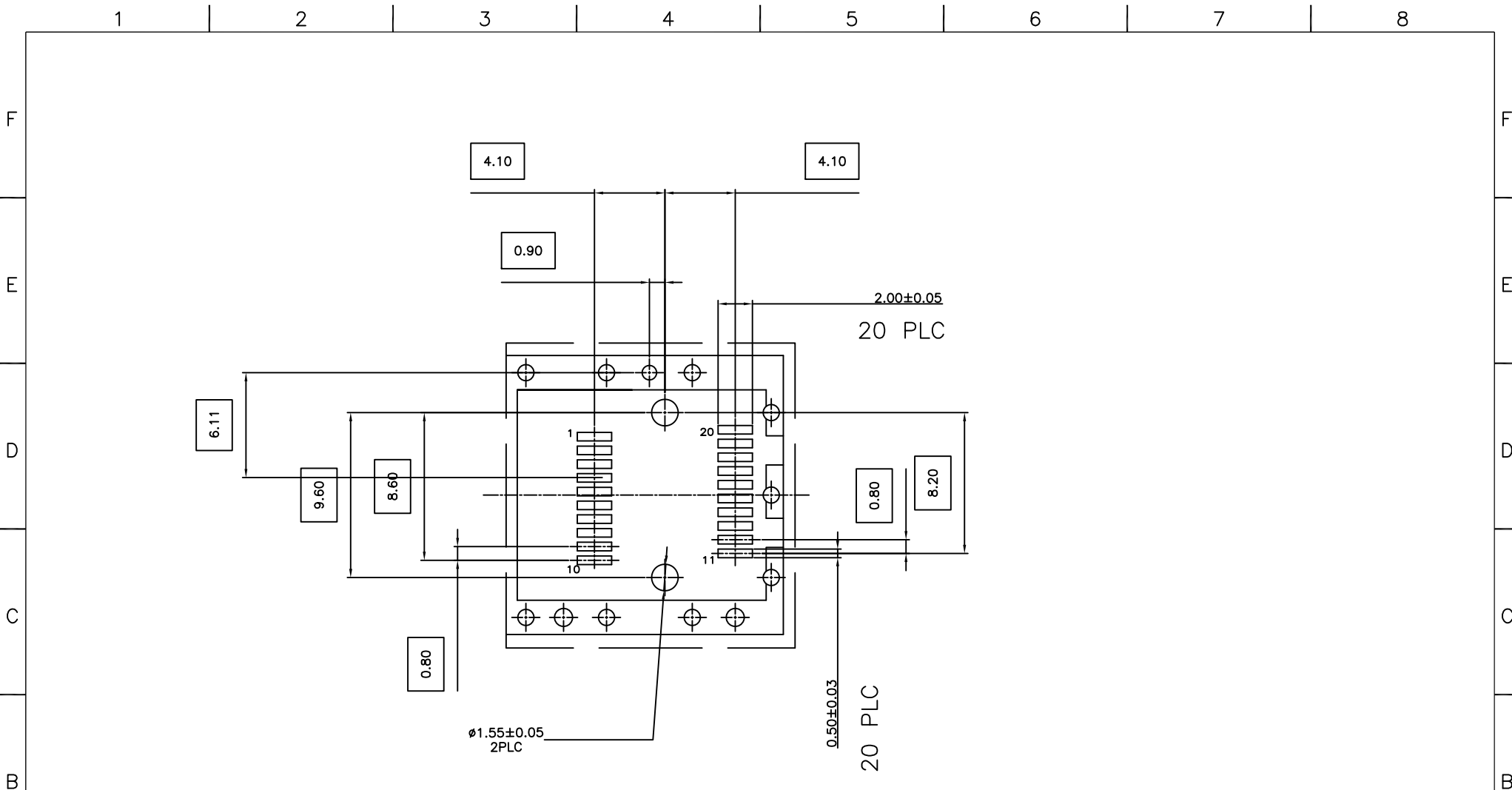


REV.	ECN. NO.	DRAWN	DATE	EC.content
A.0	NEW	Candy	02/23/2023	



⊗: QUALITY CONTROL ITEM	GENERAL TOLERANCE .X± 0.38 X.'± 2' .XX± 0.25 .X'± 1' .XXX± 0.13	PART NO.: SFW11-5030-084G-01
APPROVED		TITLE: SFP+ 1X1 CONNECTOR
CHECKED		SCALE: 1:1 SHEET: 1/3 REV.: A.0
DRAWN	UNIT: mm	

SIZE: A4

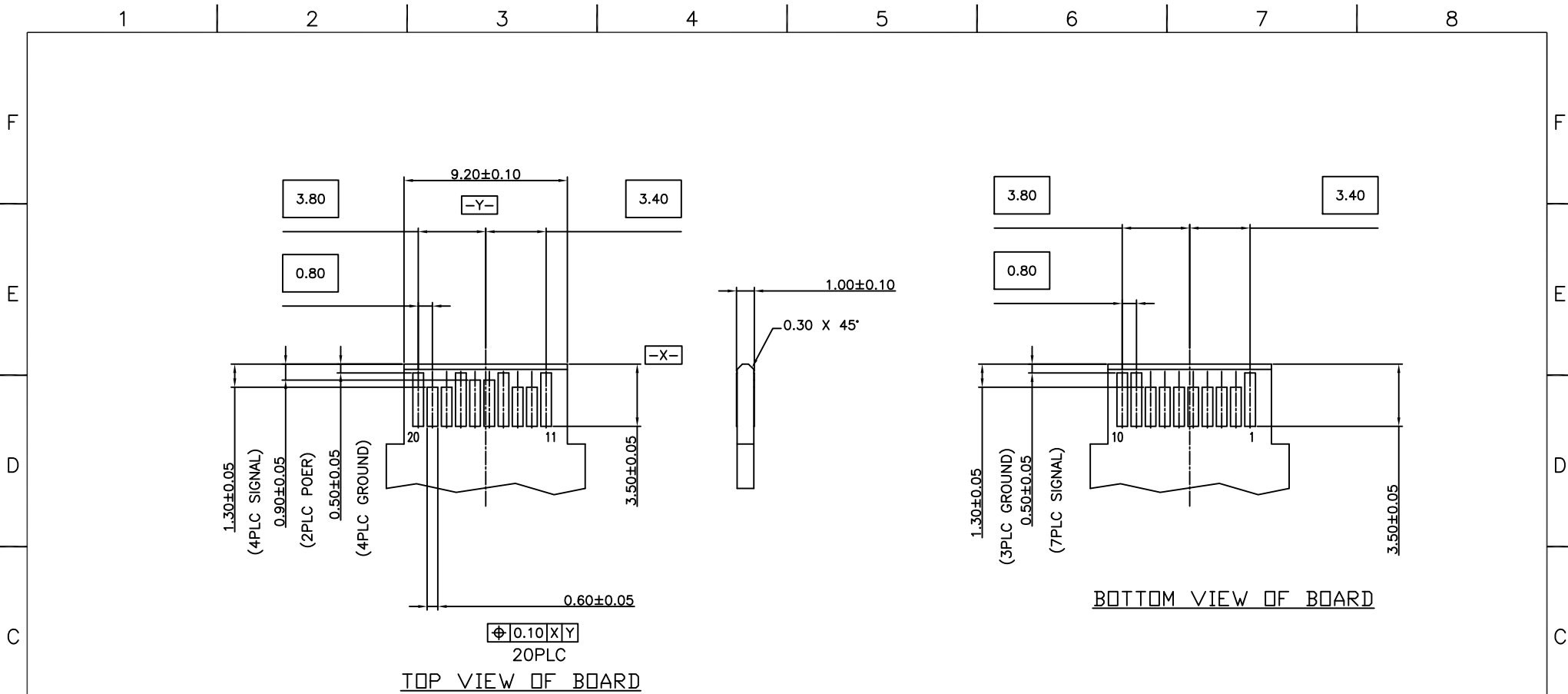


REV.	ECN. NO.	DRAWN	DATE	EC.content
A.0	NEW	Candy	02/23/2023	



⊗: QUALITY CONTROL ITEM	GENERAL TOLERANCE		PART NO.: SFW11-5030-084G-01		
APPROVED	.X± 0.38	X.'± 2'	TITLE: SFP+ 1X1 CONNECTOR		
CHECKED	.XX± 0.25	.X'± 1'			
DRAWN	.XXX± 0.13				
UNIT: mm			SCALE: 1:1	SHEET: 2/3	REV.: A.0

SIZE: A4



TOP VIEW OF BOARD

BOTTOM VIEW OF BOARD

RECOMMENDED LAYOUT DETAIL MATING TRANSCEIVER PCB

REV.	ECN. NO.	DRAWN	DATE	EC.content
A.0	NEW	Candy	02/23/2023	



⊗: QUALITY CONTROL ITEM	GENERAL TOLERANCE	PART NO.: SFW11-5030-084G-01
APPROVED	.X± 0.38 X'± 2'	TITLE: SFP+ 1X1 CONNECTOR
CHECKED	.XX± 0.25 .X'± 1'	
DRAWN	.XXX± 0.13	
	UNIT: mm	SCALE: 1:1 SHEET: 3/3 REV.: A.0

1

2

3

説明: △: 備註 ◇: 版本變更 ㊦: 尺寸序號 ■: 重點尺寸 ▼: CPK 尺寸 DOCUMENT NO.: ZER0013/A.3

SIZE: A4